

# 14MHz, Rail-to-Rail I/O CMOS Operational Amplifier

## FEATURES

- HIGH GAIN BANDWIDTH:14MHz
- RAIL-TO-RAIL INPUT AND OUTPUT  
0.8mV Typical Vos
- INPUT VOLTAGE RANGE: -0.1V to +5.6V  
with Vs = 5.5V
- SUPPLY RANGE: +2.5V to +5.5V
- SHUTDOWN: RS821S/RS822S
- SPECIFIED UP TO +125°C
- *Micro*SIZE PACKAGES: SOT23-5, SOT23-6

## APPLICATIONS

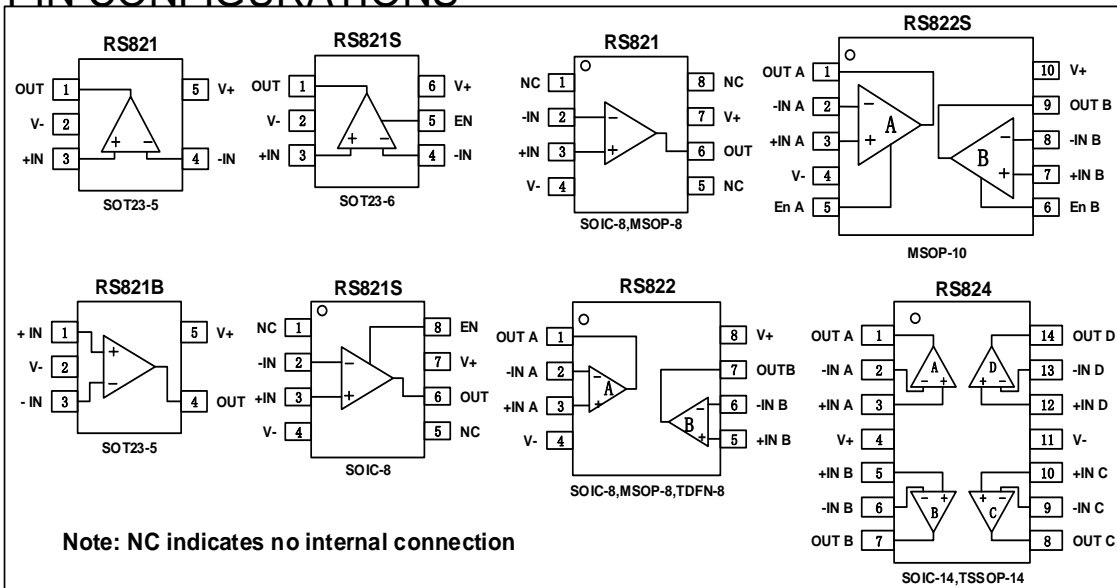
- SENSORS
- PHOTODIODE AMPLIFICATION
- ACTIVE FILTERS
- TEST EQUIPMENT
- DRIVING A/D CONVERTERS

## DESCRIPTION

The RS82X families of products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (14MHz) and slew rate of 10V/us. The op-amps are unity gain stable and feature an ultra-low input bias current.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS821S, RS822S include a shutdown mode. Under logic control, the amplifiers can be switched from normal operation to a standby current that is less than 1uA. The RS82X families of operational amplifiers are specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.5V to 5.5V.

## PIN CONFIGURATIONS



## ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>

Supply Voltage, V+ to V-	7.0V
Input Terminals, Voltage <sup>(2)</sup>	- 0.5 to (V+) + 0.5V
Current <sup>(2)</sup>	±10mA
Storage Temperature	-65°C to +150°C
Operating Temperature	-40°C to +125°C
Junction Temperature	150°C
Package Thermal Resistance @ T <sub>A</sub> = +25°C	
SOT23-5, SOT23-6	200°C/W
MSOP-10, SOIC-8	150°C/W
SOIC-14, TSSOP-14	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
HBM	5000V
MM	400V

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.



### ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	PACKAGE OPTION
RS821	RS821XK	-40°C~125°C	SOIC-8	RS821	Tape and Reel,2500
	RS821XF	-40°C~125°C	SOT23-5	821	Tape and Reel,3000
	RS821BXF	-40°C~125°C	SOT23-5	821B	Tape and Reel,3000
	RS821XM	-40°C~125°C	MSOP-8	RS821	Tape and Reel,3000
RS821S	RS821SXK	-40°C~125°C	SOIC-8	RS821S	Tape and Reel,2500
	RS821SXH	-40°C~125°C	SOT23-6	821S	Tape and Reel,3000
RS822	RS822XK	-40°C~125°C	SOIC-8	RS822	Tape and Reel,2500
	RS822XM	-40°C~125°C	MSOP-8	RS822	Tape and Reel,3000
	RS822XT	-40°C~125°C	TDFN-8	RS822	Tape and Reel,3000
RS822S	RS822SXN	-40°C~125°C	MSOP-10	RS822S	Tape and Reel,3000
RS824	RS824XP	-40°C~125°C	SOIC -14	RS824	Tape and Reel,2500
	RS824XQ	-40°C~125°C	TSSOP-14	RS824	Tape and Reel,3000

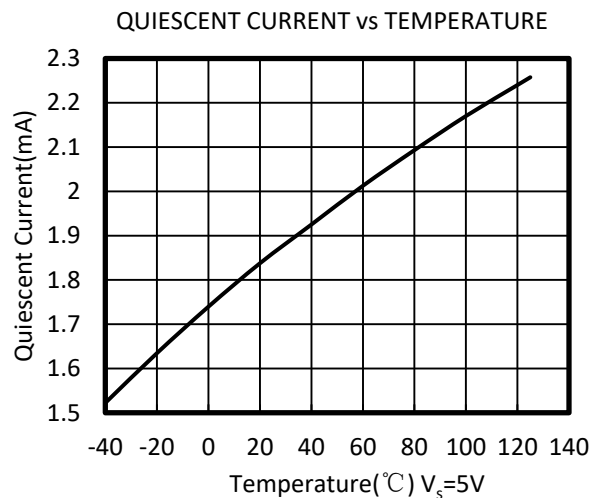
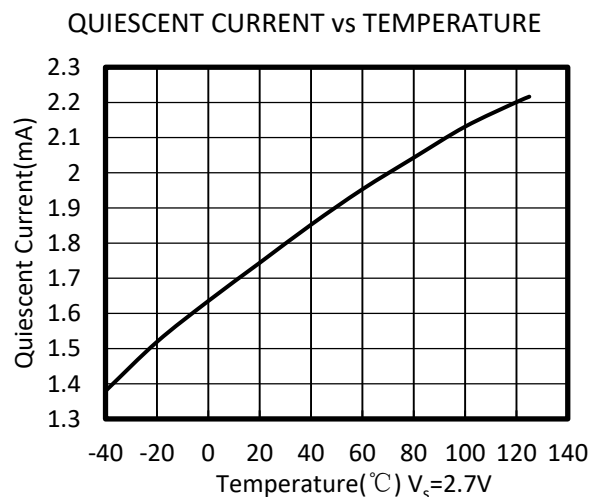
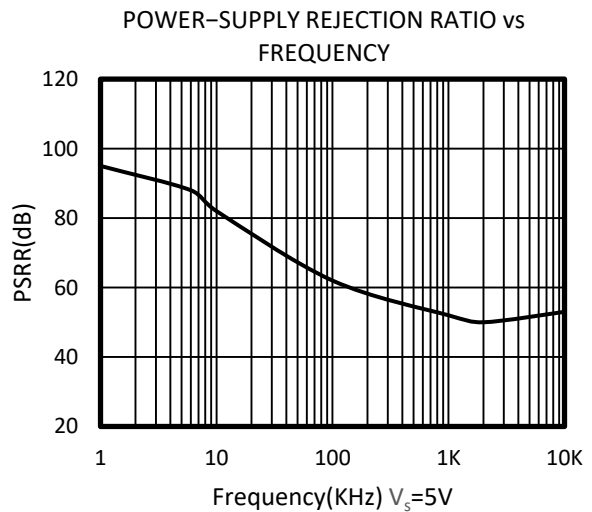
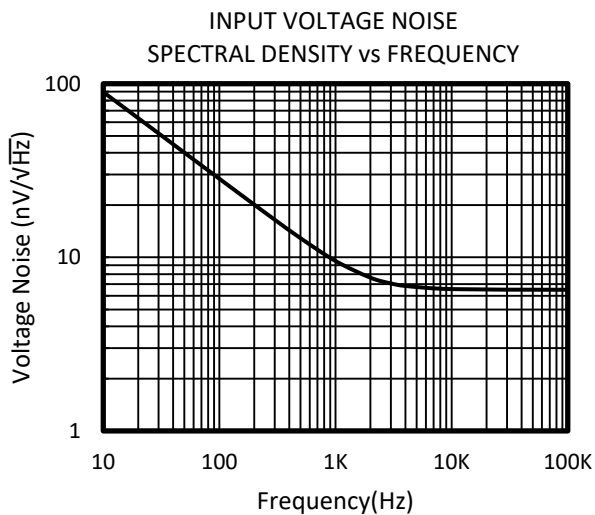
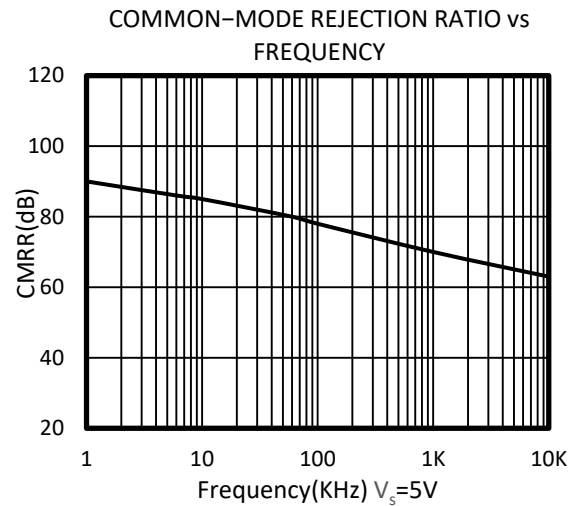
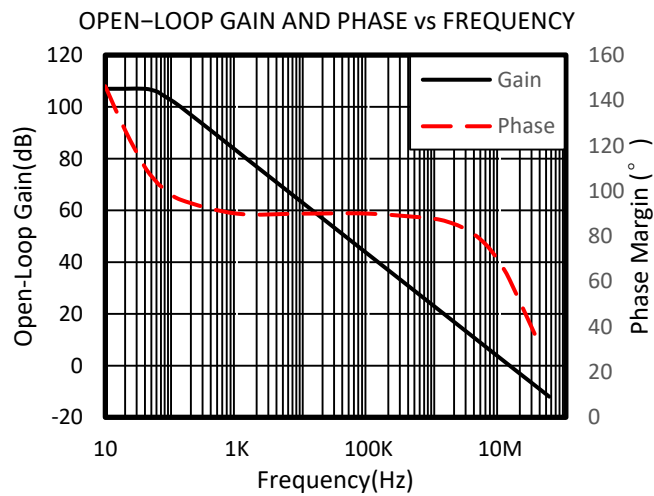
**ELECTRICAL CHARACTERISTICS**

 (At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ , and  $V_{OUT} = V_S/2$ , unless otherwise noted.)

PARAMETER		CONDITIONS	$T_J$	RS821S, RS822S, RS821, RS822, RS824			UNIT
				MIN	TYP	MAX	
<b>POWER SUPPLY</b>							
$V_S$	Operating Voltage Range		$25^\circ\text{C}$	2.5		5.5	V
$I_Q$	Quiescent Current/Amplifier		$25^\circ\text{C}$		1.9	2.5	mA
PSRR	Power-Supply Rejection Ratio	$V_S = 2.5\text{V to } 5.5\text{V}$ $V_{cm} = (V_-) + 0.5\text{V}$	$25^\circ\text{C}$	75	88		dB
			$-40^\circ\text{C to } 125^\circ\text{C}$	65			
<b>INPUT</b>							
$V_{os}$	Input Offset Voltage		$25^\circ\text{C}$		0.8	3	mV
$V_{os\ TC}$	Input Offset Voltage Average Drift	$-40^\circ\text{C to } 125^\circ\text{C}$			1.6		$\mu\text{V}/^\circ\text{C}$
$I_B$	Input Bias Current		$25^\circ\text{C}$		1	10	pA
$I_{os}$	Input Offset Current		$25^\circ\text{C}$		1	10	pA
$V_{cm}$	Common-Mode Voltage Range	$V_S = 5.5\text{V}$	$25^\circ\text{C}$	-0.1		5.6	V
CMRR	Common-Mode Rejection Ratio	$V_S = 5.5\text{V}$ , $V_{cm} = -0.1\text{V to } 4\text{V}$	$25^\circ\text{C}$	75	88		dB
			$-40^\circ\text{C to } 125^\circ\text{C}$	67			
		$V_S = 5.5\text{V}$ , $V_{cm} = -0.1\text{V to } 5.6\text{V}$	$25^\circ\text{C}$	61	75		
			$-40^\circ\text{C to } 125^\circ\text{C}$	58			
<b>OUTPUT</b>							
AOL	Open-Loop Voltage Gain	$R_L = 2\text{k}\Omega$ , $V_o = 0.15\text{V to } 4.85\text{V}$	$25^\circ\text{C}$	91	100		dB
			$-40^\circ\text{C to } 125^\circ\text{C}$	78			
		$R_L = 10\text{k}\Omega$ , $V_o = 0.05\text{V to } 4.95\text{V}$	$25^\circ\text{C}$	89	98		
			$-40^\circ\text{C to } 125^\circ\text{C}$	75			
	Output Swing From Rail	$R_L = 2\text{k}\Omega$	$25^\circ\text{C}$		20		mV
		$R_L = 10\text{k}\Omega$	$25^\circ\text{C}$		7		
$I_{out}$	Output Short-Circuit Current		$25^\circ\text{C}$		110		mA
<b>FREQUENCY RESPONSE</b>							
SR	Slew Rate		$25^\circ\text{C}$		10		V/ $\mu\text{s}$
GBP	Gain-Bandwidth Product		$25^\circ\text{C}$		14		MHz
$\Phi_m$	Phase Margin		$25^\circ\text{C}$		58		$^\circ$
$t_s$	Settling Time, 0.1%				0.2		$\mu\text{s}$
	Overload Recovery Time	$V_{IN} \cdot \text{Gain} \geq V_S$			0.3		$\mu\text{s}$
<b>NOISE</b>							
$e_n$	Input-Referred Voltage Noise	$f = 1\text{ kHz}$	$25^\circ\text{C}$		8.5		nV/ $\sqrt{\text{Hz}}$
		$f = 10\text{ kHz}$	$25^\circ\text{C}$		5.5		nV/ $\sqrt{\text{Hz}}$
<b>ENABLE/SHUTTDOWN(RS821S,RS822S)</b>							
$I_{Q(OFF)}$	Supply Current in Shutdown		$25^\circ\text{C}$		<1		$\mu\text{A}$
$t_{OFF}$			$25^\circ\text{C}$		3		$\mu\text{s}$
$t_{ON}$			$25^\circ\text{C}$		20		$\mu\text{s}$
$V_L$	Shut Down		$25^\circ\text{C}$	$V_-$		$(V_-) + 0.8$	V
$V_H$	Amplifier Is Active		$25^\circ\text{C}$	$(V_-) + 2$		$V_+$	V

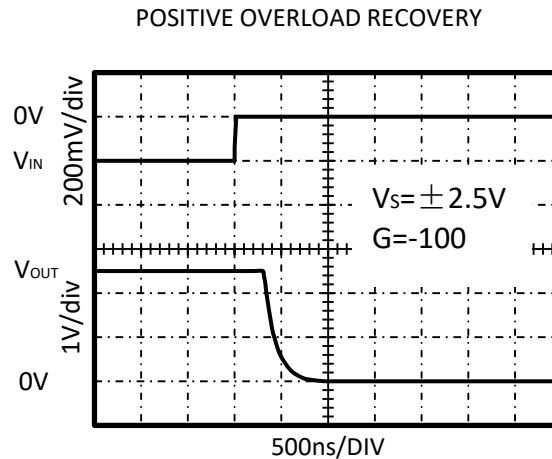
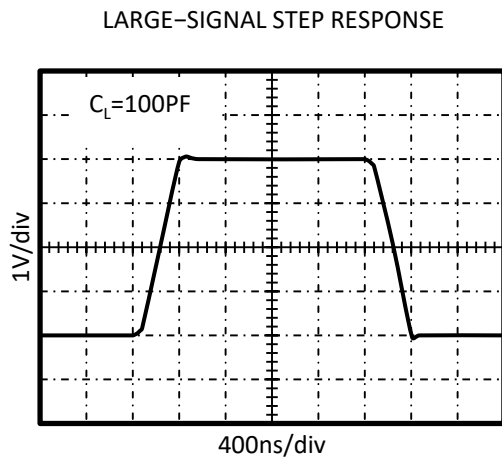
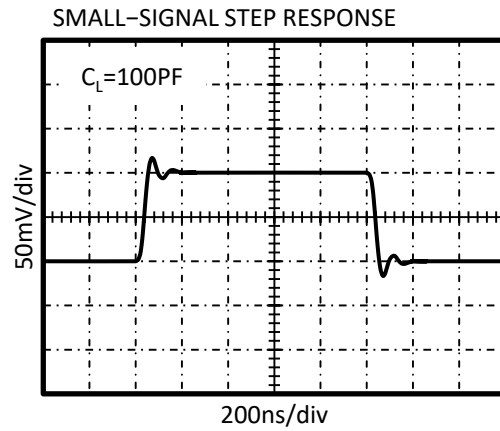
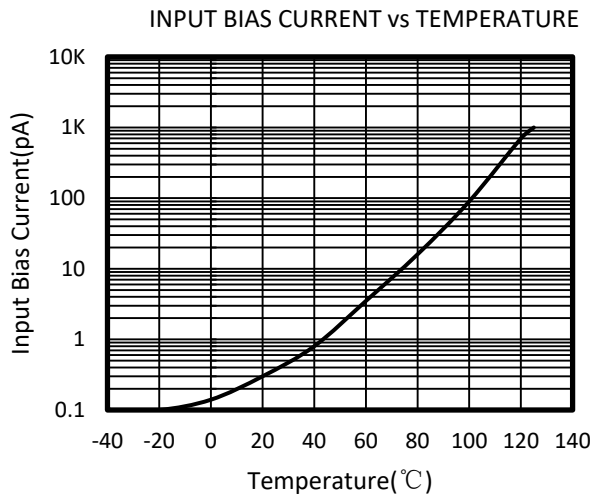
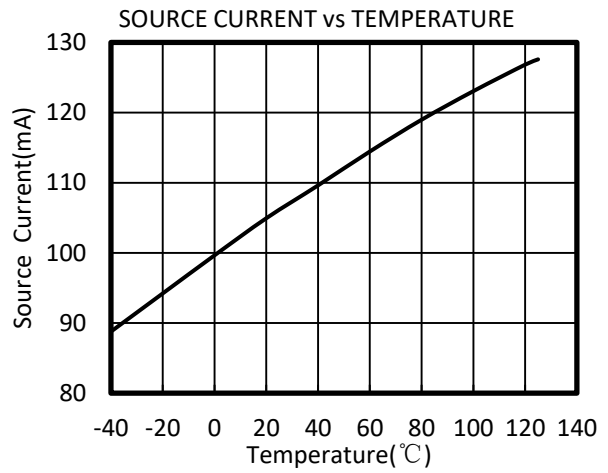
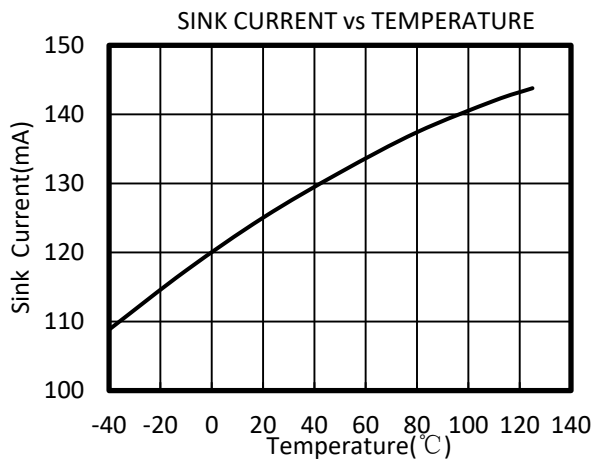
## TYPICAL CHARACTERISTICS

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$ , unless otherwise noted.



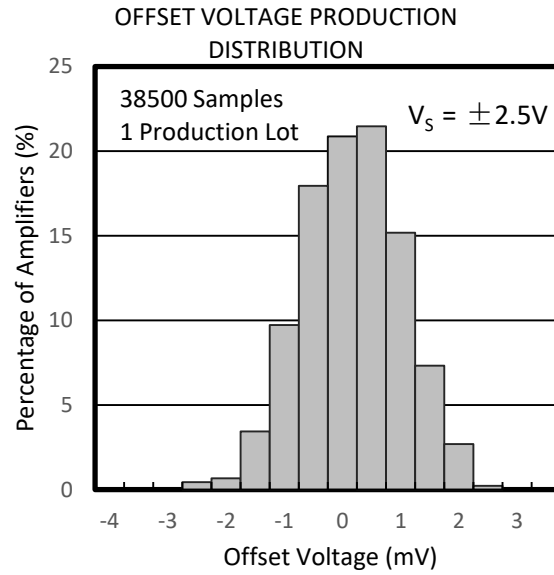
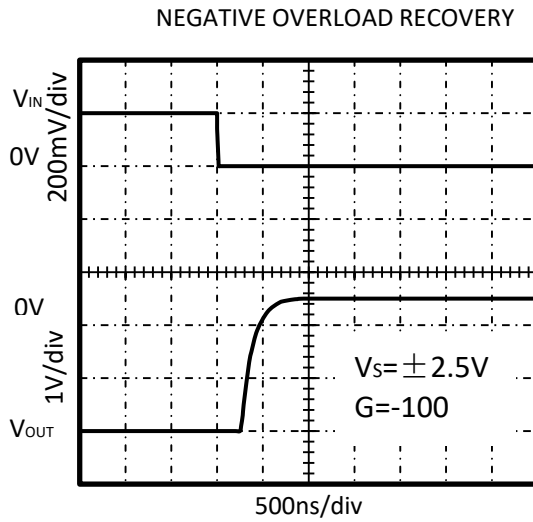
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At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$  connected to  $V_S/2$ ,  $V_{OUT} = V_S/2$ , unless otherwise noted.



## APPLICATION NOTES

The RS821, RS822, RS824, RS821S, RS822S are high precision, rail-to-rail operational amplifiers that can be run from a single-supply voltage 2.5V to 5.5V ( $\pm 1.25V$  to  $\pm 2.75V$ ). Supply voltages higher than 7V (absolute maximum) can permanently damage the amplifier.

Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications.

Good layout practice mandates use of a 0.1uF capacitor place closely across the supply pins.

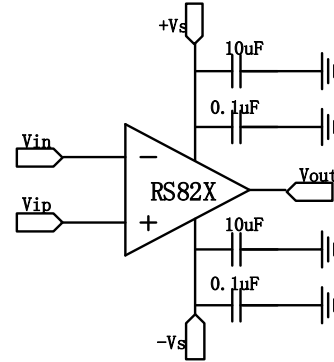


Figure1. Amplifier with Bypass Capacitors

## RS821S/RS822S ENABLE FUNCTION

The RS821S/RS822S includes a shutdown mode. Under logic control, the amplifiers can be switched from normal mode to a standby current of 1uA. When the Enable pin is connected to high, the amplifier is active. Connecting Enable low disables the amplifier, and places the amplifier, and place the output in a high-impedance state.

## LAYOUT GUIDELINS

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1uF capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

## INSTRUMENTATION AMPLIFIER

In the three-op amp, instrumentation amplifier configuration shown in Figure2,

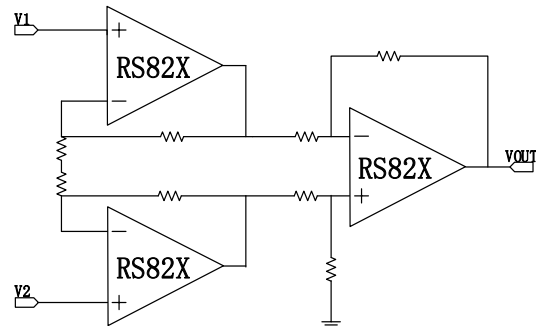
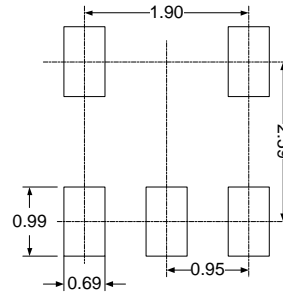
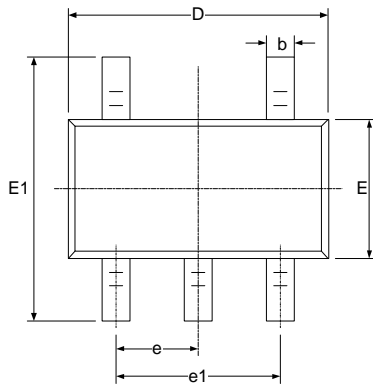
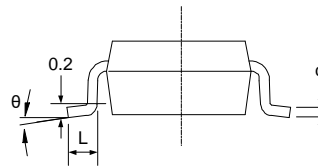
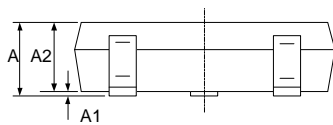


Figure2. Amplifier instrumentation amplifier

## PACKAGE OUTLINE DIMENSIONS SOT23-5



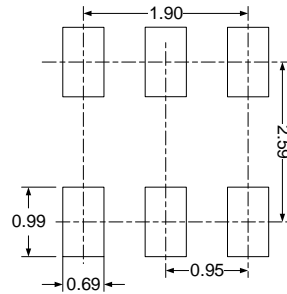
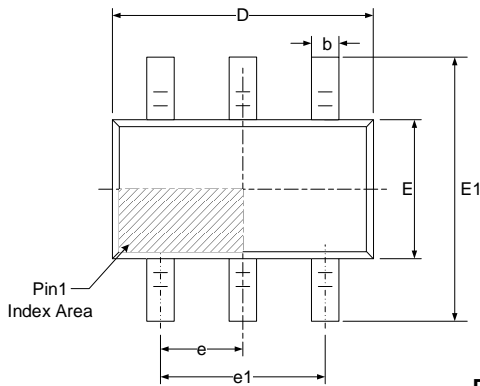
RECOMMENDED LAND PATTERN (Unit: mm)



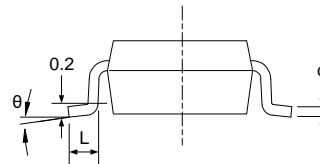
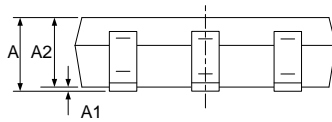
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°



# SOT23-6

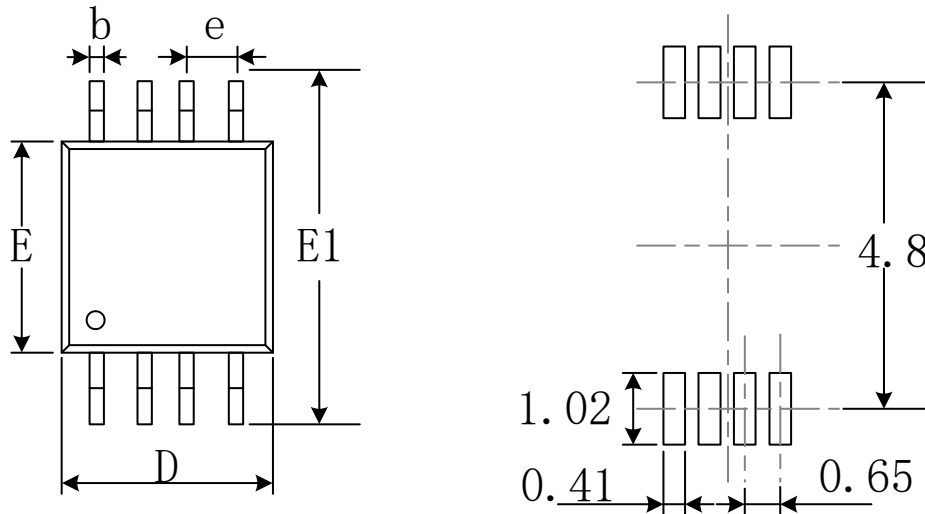


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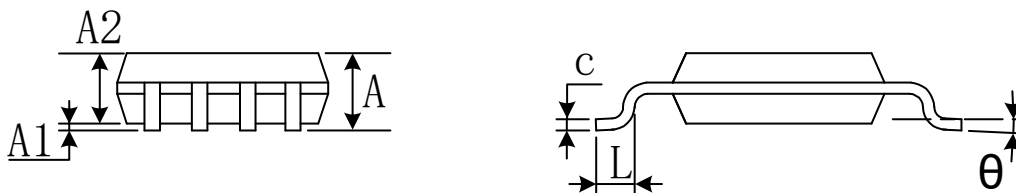


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°

# MSOP-8

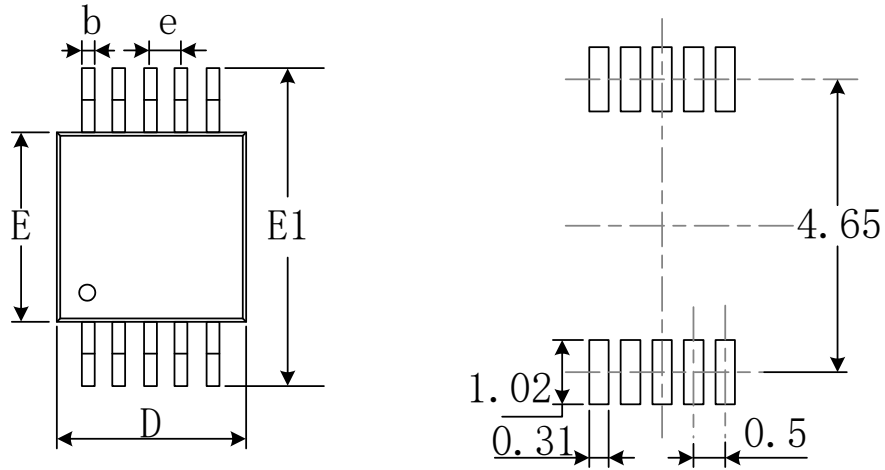


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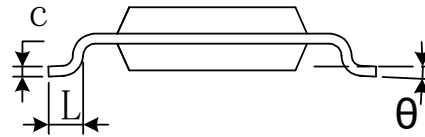
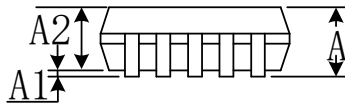


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
$\theta$	0°	6°	0°	6°

# MSOP-10

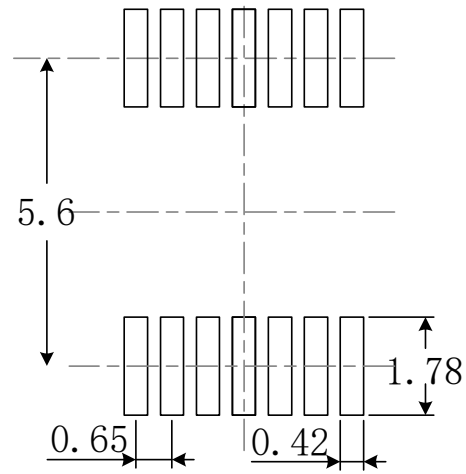
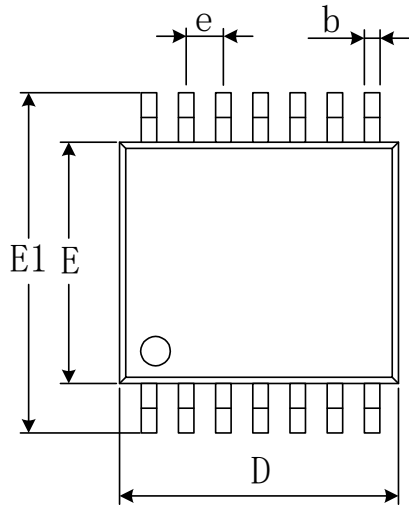


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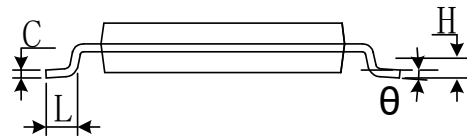
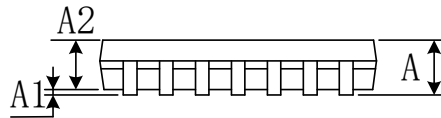


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.180	0.280	0.007	0.011
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.50(BSC)		0.020(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

# TSSOP-14

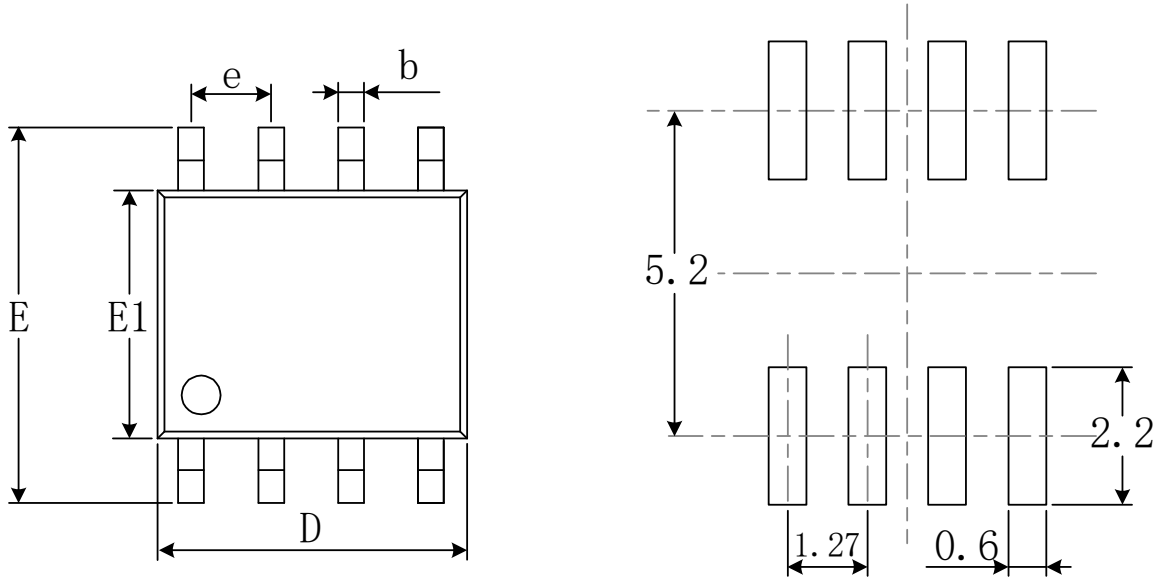


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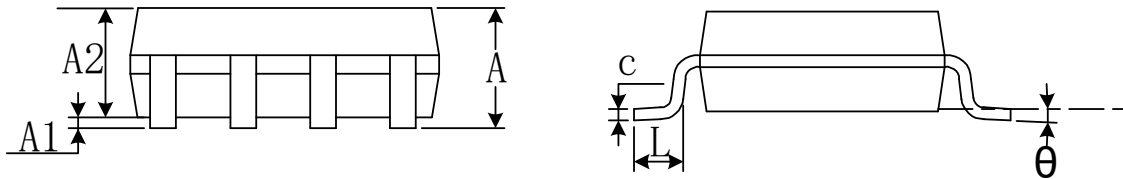


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
$\theta$	1°	7°	1°	7°

# SOIC-8

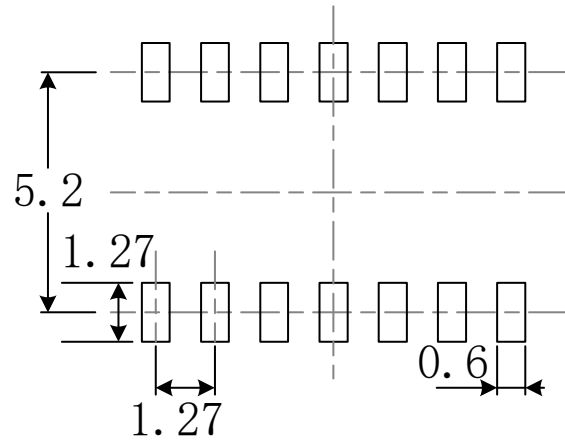
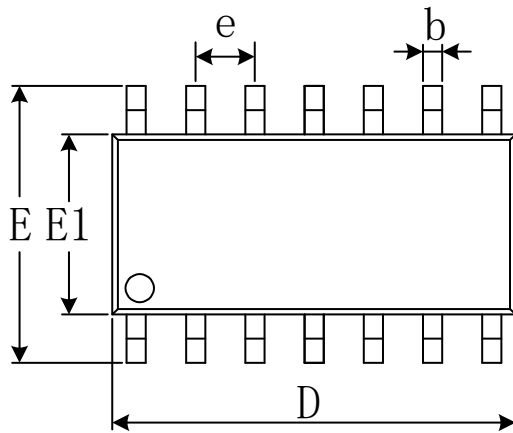


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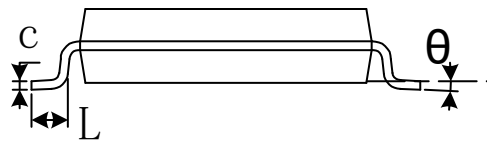
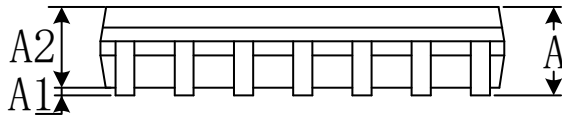


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
$\theta$	0°	8°	0°	8°

# SOIC-14

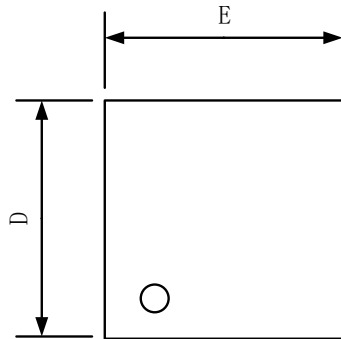


RECOMMENDED LAND PATTERN (Unit: mm)

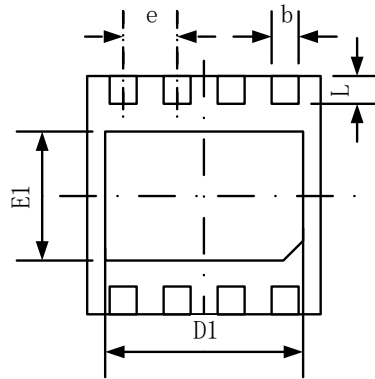


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
$\theta$	0°	8°	0°	8°

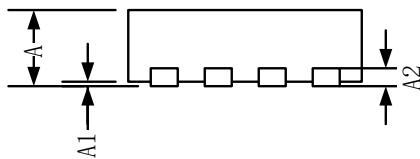
# TDFN-3x3-8L



TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203		0.008	
b	0.300	0.400	0.012	0.016
D	2.900	3.100	0.114	0.122
D1	2.510	2.610	0.099	0.103
E	2.900	3.100	0.114	0.122
E1	1.550	1.650	0.061	0.065
e	0.650 TYP		0.026 TYP	
L	0.350	0.450	0.014	0.018